

MOSFET

OptiMOS[™] 5 Power-Transistor, 100 V

Features

- Ideal for high frequency switching and sync. rec.
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 N-channel, normal level

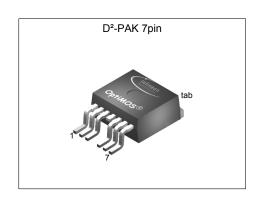
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

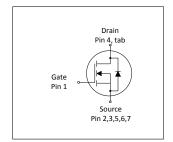
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

| Parameter | Value | Unit | | | | | | |
|-------------------------|-------|------|--|--|--|--|--|--|
| V _{DS} | 100 | V | | | | | | |
| R _{DS(on),max} | 1.53 | mΩ | | | | | | |
| I _D | 276 | A | | | | | | |
| Qoss | 213 | nC | | | | | | |
| Q _G | 168 | nC | | | | | | |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|----------|---------------|
| IPF015N10N5 | PG-TO263-7 | 015N10N5 | - |

OptiMOS[™] 5 Power-Transistor, 100 V IPF015N10N5



Table of Contents

| Description | . 1 |
|-------------------------------------|-----|
| Maximum ratings | . 3 |
| hermal characteristics | . 3 |
| Electrical characteristics | . 4 |
| Electrical characteristics diagrams | . 6 |
| Package Outlines | 10 |
| Revision History | 11 |
| rademarks | 11 |
| Disclaimer | 11 |

OptiMOS[™] 5 Power-Transistor, 100 V IPF015N10N5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

| Davamatar | C. mahal | Values | | | | Note / Tool Opendition | |
|--|-----------------------------------|----------------|---|------------------|------|--|--|
| Parameter | Symbol | Min. Typ. Max. | | Max. | Unit | Note / Test Condition | |
| Continuous drain current ¹⁾ | ID | - - - | - | 276 211 35 | A | V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =10 V, T _A =25 °C, R _{thJA} =40 °C/W ²) | |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 1104 | Α | <i>T</i> _C =25 °C | |
| Avalanche energy, single pulse ⁴⁾ | E AS | - | - | 1166 | mJ | I_D =100 A, R_{GS} =25 Ω | |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - | |
| Power dissipation | P _{tot} | - | - | 375 3.8 | W | T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾ | |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 175 | °C | IEC climatic category; DIN IEC 68-1 55/175/56 | |

2 Thermal characteristics

Table 3 Thermal characteristics

| Doromotor | Cumbal | Values | | | Unit | Note / Took Condition | |
|--|-------------------|--------|------|------|------|-----------------------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Thermal resistance, junction - case | R _{thJC} | - | 0.3 | 0.4 | °C/W | - | |
| Thermal resistance, junction - ambient, 6 cm² cooling area²) | R _{thJA} | - | - | 40 | °C/W | - | |
| Thermal resistance, junction - ambient, minimal footprint | ↑ thJA | - | - | 62 | °C/W | - | |
| Soldering temperature, wave and reflow soldering are allowed | T _{sold} | - | - | 260 | °C | reflow MSL1 | |

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

OptiMOS[™] 5 Power-Transistor, 100 V IPF015N10N5



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

| Damain Adam | 0 | Values | | | | | |
|----------------------------------|----------------------|--------|------------|-------------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Drain-source breakdown voltage | V _{(BR)DSS} | 100 | - | - | V | V _{GS} =0 V, I _D =1 mA | |
| Gate threshold voltage | V _{GS(th)} | 2.2 | 3.0 | 3.8 | V | V _{DS} =V _{GS} , I _D =279 μA | |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 5 100 | μΑ | V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C | |
| Gate-source leakage current | I_{GSS} | - | 1.0 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V | |
| Drain-source on-state resistance | R _{DS(on)} | - | 1.4 1.7 | 1.53 2.0 | mΩ | V _{GS} =10 V, I _D =100 A V _{GS} =6 V, I _D =50 A | |
| Gate resistance ¹⁾ | R _G | - | 1.3 | 2.0 | Ω | - | |
| Transconductance | g fs | 130 | 260 | - | S | <i>V</i> _{DS} ≥2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =100 A | |

Table 5 Dynamic characteristics

| Danamatan | O b l | | Values | | | N (7 10 10) | |
|--|------------------|------|--------|-------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Input capacitance ¹⁾ | Ciss | - | 12000 | 16000 | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz | |
| Output capacitance ¹⁾ | Coss | - | 1800 | 2300 | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz | |
| Reverse transfer capacitance ¹⁾ | C _{rss} | - | 80 | 140 | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz | |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 33 | _ | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω | |
| Rise time | t _r | - | 23 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω | |
| Turn-off delay time | $t_{ m d(off)}$ | - | 80 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω | |
| Fall time | t _f | - | 27 | _ | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω | |

Table 6 Gate charge characteristics²⁾

| Parameter | Cymbal | Values | | | 11 | Note / Took Condition | |
|------------------------------------|----------------------|--------|------|------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Gate to source charge | Q _{gs} | - | 53 | - | nC | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V | |
| Gate charge at threshold | $Q_{g(th)}$ | - | 36 | - | nC | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V | |
| Gate to drain charge ¹⁾ | $Q_{ m gd}$ | - | 34 | 51 | nC | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V | |
| Switching charge | Q _{sw} | - | 51 | - | nC | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V | |
| Gate charge total ¹⁾ | Qg | - | 168 | 210 | nC | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V | |
| Gate plateau voltage | V _{plateau} | - | 4.4 | - | V | V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V | |
| Output charge ¹⁾ | Qoss | - | 213 | 283 | nC | V _{DS} =50 V, V _{GS} =0 V | |

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

OptiMOS[™] 5 Power-Transistor, 100 V IPF015N10N5

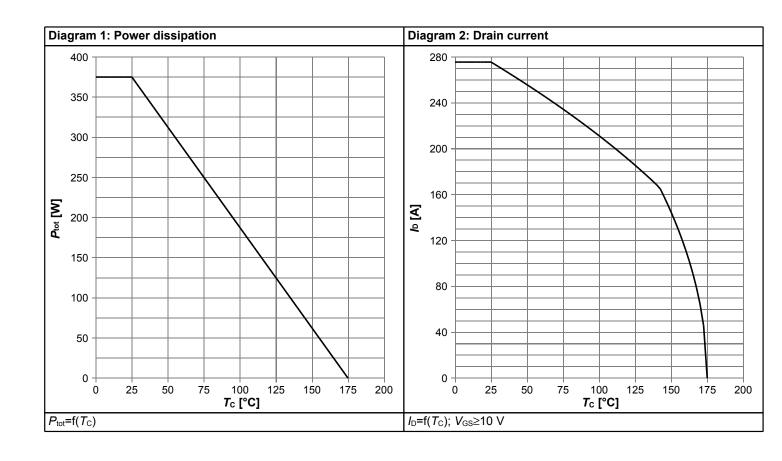


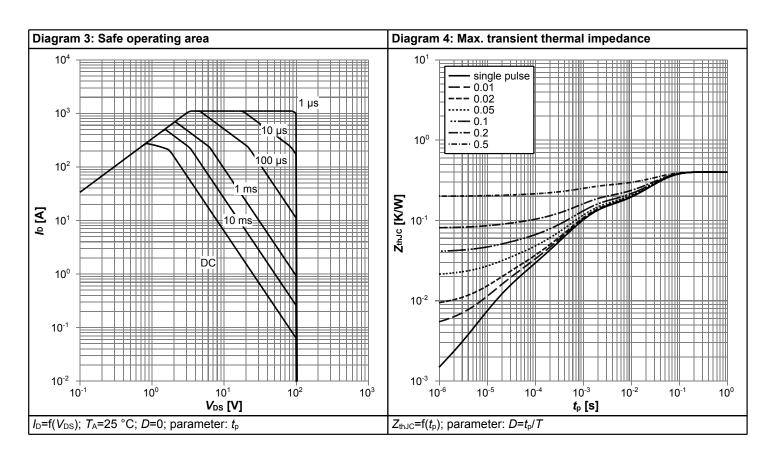
Table 7 Reverse diode

| Dougraphou | Cumbal | | Values | | | Nata (Tant Oan dittan | |
|---|----------------------|------|--------|------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Diode continuous forward current | I _S | - | - | 268 | Α | <i>T</i> _C =25 °C | |
| Diode pulse current | I _{S,pulse} | - | - | 1104 | Α | T _C =25 °C | |
| Diode forward voltage | V _{SD} | - | 0.86 | 1.0 | V | V _{GS} =0 V, I _F =100 A, T _j =25 °C | |
| Reverse recovery time ¹⁾ | t _{rr} | - | 88 | 176 | ns | V _R =50 V, I _F =100 A, di _F /dt=100 A/μs | |
| Reverse recovery charge ¹⁾ Q _{rr} | | - | 235 | 470 | nC | V _R =50 V, I _F =100 A, di _F /dt=100 A/μs | |

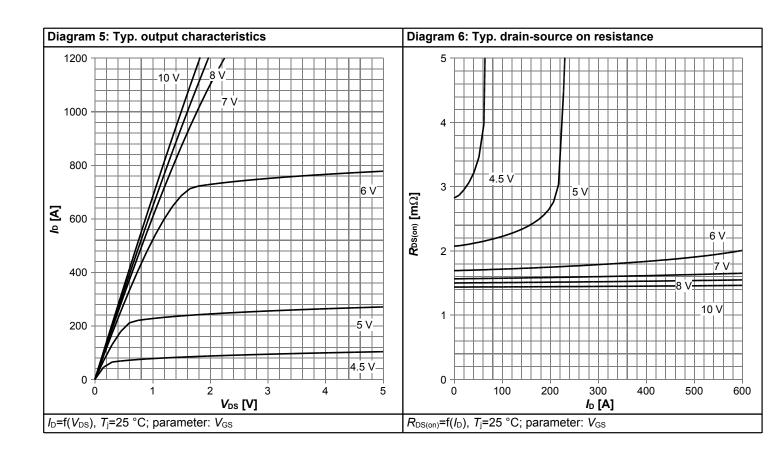


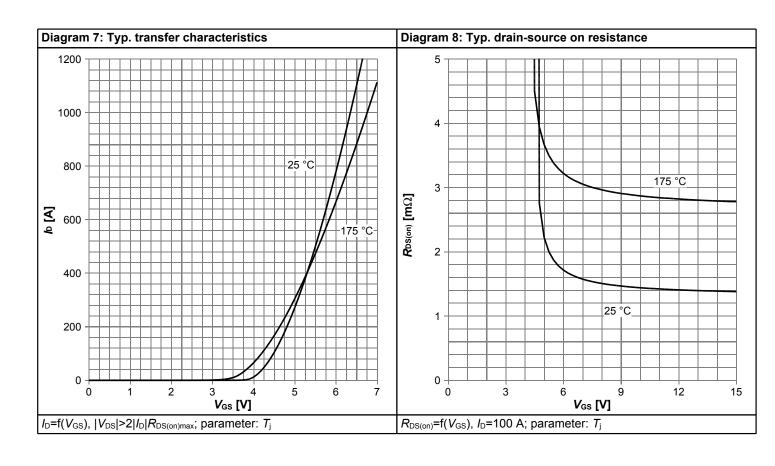
4 Electrical characteristics diagrams



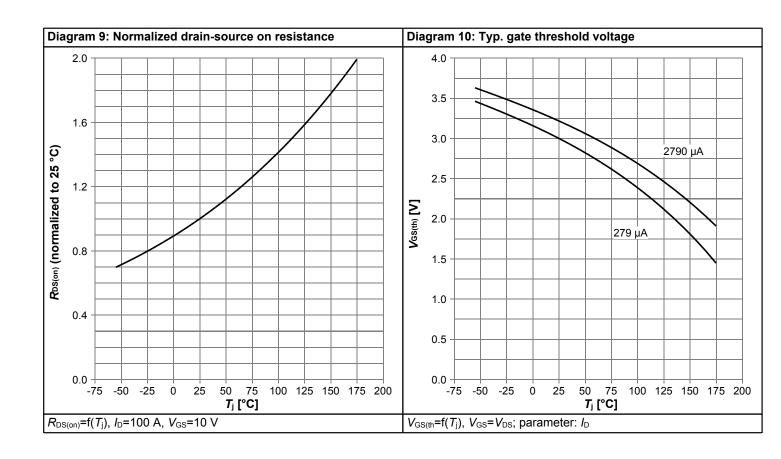


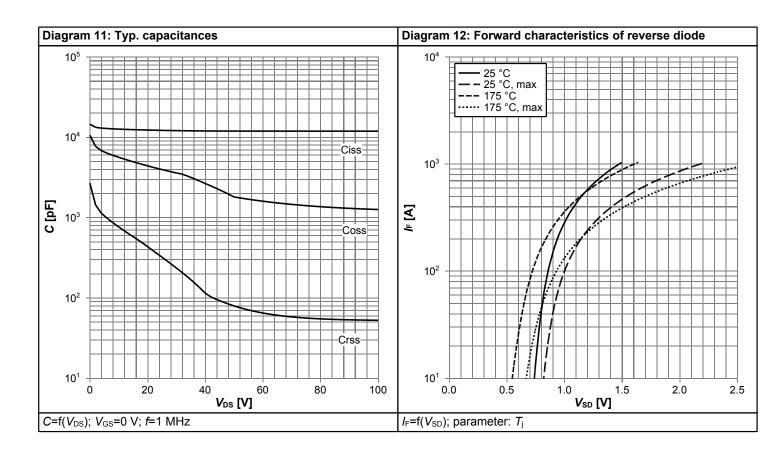




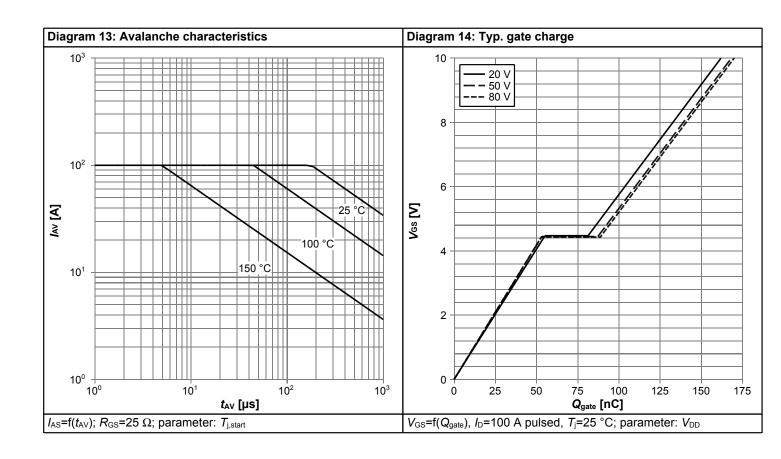


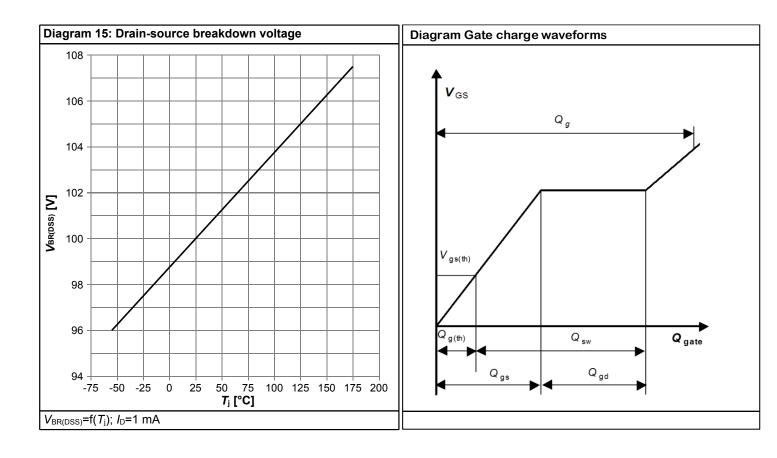






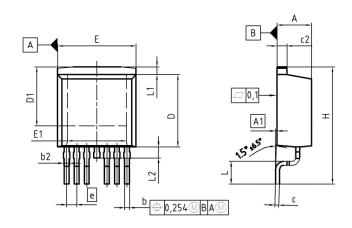


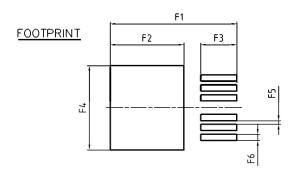






5 Package Outlines





| DIM MILLIMETERS | | IETERS | INC | HES | |
|-----------------|-------|--------|-------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 4.30 | 4.57 | 0.169 | 0.180 | |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 | |
| Ь | 0.50 | 0.70 | 0.020 | 0.028 | |
| b2 | 0.50 | 1.00 | 0.020 | 0.039 | |
| С | 0.33 | 0.65 | 0.013 | 0.026 | |
| c2 | 1.17 | 1.40 | 0.046 | 0.055 | |
| D | 8.51 | 9.45 | 0.335 | 0.372 | |
| D1 | 6.90 | 7.90 | 0.272 | 0.311 | |
| E | 9.80 | 10.31 | 0.386 | 0.406 | |
| E1 | 6.50 | 8.60 | 0.256 | 0.339 | |
| е | 1. | 27 | 0.050 | | |
| N | | 6 | 6 | | |
| Н | 14.61 | 15.88 | 0.575 | 0.625 | |
| L | 2.29 | 3.00 | 0.090 | 0.118 | |
| L1 | 0.70 | 1.60 | 0.028 | 0.063 | |
| L2 | 1.00 | 1.78 | 0.039 | 0.070 | |
| F1 | 16.05 | 16.25 | 0.632 | 0.640 | |
| F2 | 9,30 | 9.50 | 0.366 | 0.374 | |
| F3 | 4.50 | 4.70 | 0.177 | 0.185 | |
| F4 | 10.70 | 10.90 | 0.421 | 0.429 | |
| F5 | 0.37 | 0.57 | 0.015 | 0.022 | |
| F6 | 0.70 | 0.90 | 0.028 | 0.035 | |

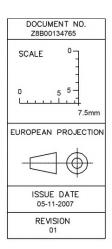


Figure 1 Outline PG-TO263-7, dimensions in mm/inches

OptiMOS[™] 5 Power-Transistor, 100 V



Revision History

IPF015N10N5

Revision: 2022-03-28, Rev. 2.1

Previous Revision

| r revious r | r revious revision | | | | | | |
|-------------|---|-------------------------------|--|--|--|--|--|
| Revision | Date Subjects (major changes since last revision) | | | | | | |
| 2.0 | 2022-02-16 | Release of final version | | | | | |
| 2.1 | 2022-03-28 | Update Rds(on) max at Vgs=10V | | | | | |

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to: erratum@infineon.com

Published by Infineon Technologies AG 81726 München, Germany © 2022 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.